Surface Mount Thin-Film Filters

 50Ω DC to 40 GHz

The Big Deal

- Low passband insertion loss
- High rejection
- · Good power handling
- Temperature stability -55°C to 125°C
- High repeatability
- RoHS complaint
- Small size



Product Overview

Mini-Circuits' Surface Mount Thin-Film filters offer low insertion loss and high rejection realized via Thin-Film on Alumina substrate, using a sputtering process that can guarantee a enhanced Q and repeatable performance.

Low pass, high pass and bandpass surface mount thin-film designs can be realized with this technology. Using thin-film manufacturing, we can guarantee repeatability on large batches of filters. Thin-film filters are small in size with high-quality, precise machining for applications where size is critical.

Key Features

| Feature | Advantages | |
|--------------------------------|---|--|
| Low insertion loss | High Q material and sputtering process results in lower insertion loss, better SNR is obtained. | |
| Fast roll-off (steeper skirts) | ligh selectivity results in better adjacent channel rejection and dynamic range | |
| Wider stopband | Wide spur-free stopband results in better adjacent channel rejection and dynamic range | |
| Temperature stability | Very minimal change in electrical performance across temperature makes these filters suitable for a wide range of operating conditions. | |
| Small Size | Various design techniques are employed to realize small size. | |



Notes
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



Bandpass Filter

50Ω 24250 to 27500 MHz

ABF-26G+



Generic photo used for illustration purposes only

CASE STYLE: VG3044

Electrical Specifications(1) at 25°C

| Parameter | | F# | Frequency (MHz) | Min. | Тур. | Max. | Unit |
|------------------|------------------|-------|-----------------|------|------|------|------|
| | Center Frequency | Fc | 25875 | _ | 1.8 | 3.0 | dB |
| Pass Band | Insertion Loss | F1-F2 | 24250 - 27500 | _ | 3.5 | _ | dB |
| | Return Loss | F1-F2 | 24250 - 27500 | _ | 15 | _ | dB |
| Oten Dend Leven | In-antino I and | DC-F3 | DC - 20000 | 30 | 45 | _ | dB |
| Stop Band, Lower | Insertion Loss | F3-F4 | 20000 - 22500 | 25 | 45 | _ | dB |
| | | F5-F6 | 29250 - 31000 | 25 | 45 | _ | dB |
| Stop Band, Upper | Insertion Loss | F6-F7 | 31000 - 35000 | 40 | 60 | _ | dB |
| | | F7-F8 | 35000 - 40000 | _ | 40 | _ | dB |

^{1.} Measured on Mini-Circuits Characterization Test Board TB-ABF-26G+

| Maximum Ratings | | | | | |
|-----------------------|----------------|--|--|--|--|
| Operating Temperature | -55°C to 125°C | | | | |
| Storage Temperature | -55°C to 125°C | | | | |
| RF Power Input | 1W Max. @ 25°C | | | | |

Permanent damage may occur if any of these limits are exceeded.

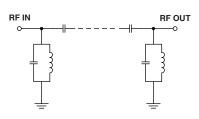
Features

- · Low mid band insertion loss of 1.8 dB typ.
- 15 dB typ. return loss in entire passband
- 60 dB typ. rejection
- · Shielded component

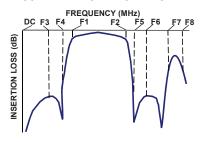
Applications

- n258
- 5G Telecommunication

Functional Schematic



Typical Frequency Response

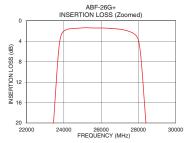


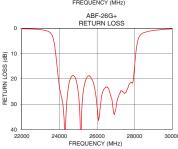
+RoHS Compliant

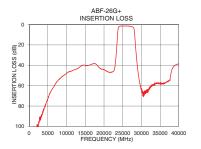
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Typical Performance Data at 25°C

| Frequency (MHz) | Insertion Loss (dB) | Return Loss (dB) |
|--------------------|------------------------|---------------------|
| 10 | 114.71 | 0.03 |
| 1000 | 105.71 | 0.21 |
| 10000 | 47.76 | 0.06 |
| 20000 | 44.38 | 0.23 |
| 22500 | 45.94 | 0.32 |
| 23225 | 30.43 | 0.87 |
| 23450 | 19.55 | 1.45 |
| 23825 | 3.17 | 11.78 |
| 24250 | 1.61 | 36.24 |
| 25875 | 1.40 | 23.68 |
| 26000 | 1.39 | 30.94 |
| 27000 | 1.63 | 31.78 |
| 27500 | 2.07 | 25.48 |
| 27900 | 3.01 | 21.48 |
| 28400 | 19.95 | 2.08 |
| 28625 | 30.01 | 1.46 |
| 29250 | 50.51 | 0.68 |
| 31000 | 65.18 | 0.05 |
| 35000 | 57.52 | 0.50 |
| 40000 | 38.60 | 0.74 |





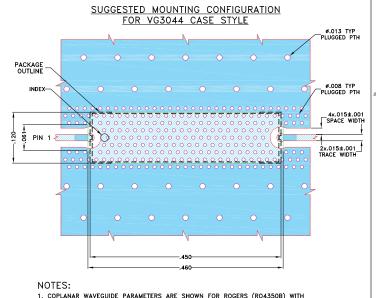


Notes
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Pad Connections

| RF IN | 1 |
|--------|---|
| RF OUT | 2 |
| GROUND | 3 |

Demo Board MCL P/N: TB-ABF-26G+ Suggested PCB Layout (PL-713)



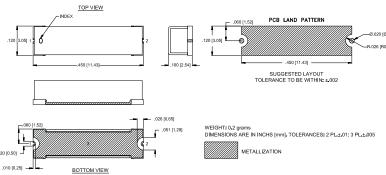
DIELECTRIC THICKNESS .0066±.0007. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.

DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)

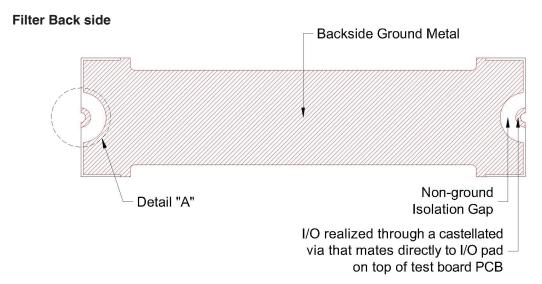
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

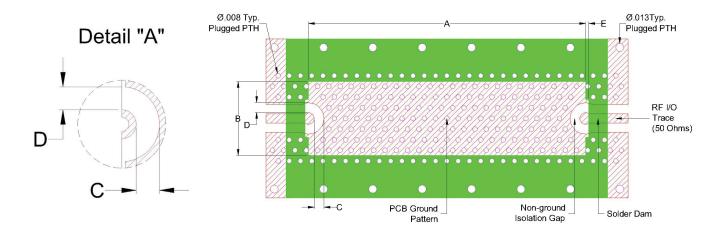
Outline Drawing



Recommendations of PCB pattern at customer board



Notes
A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp



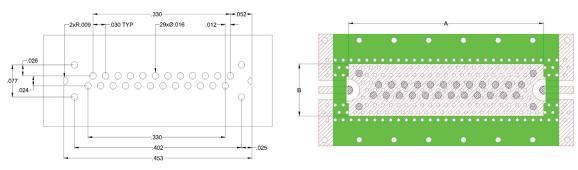
- 1) Customer PCB's ground pattern length (dimension A) can be similar to filter length.
- 2) Customer PCB's ground pattern width (dimension B) can be similar filter width.
- 3) Dimensions C and D on Filter RF I/O detail and Customer PCB pattern can be closely match. The dimensions of C and D on the Customer PCB pattern can be slightly larger to account for component alignment tolerance (ground metal can be pulled back from RF I/O trace).
- 4) Recommend to use solder mask at Customer PCB at outer area of filter pattern/footprint without any clearance.
- 5) Recommended to use Solder mask at I/O of Customer PCB with 5 mil clearance from filter I/O edge (dimension E)

Comments on component handling and solder attach

- 1) Avoid using soldering iron directly to the ceramic filter. This would lead to development of crack in the component due to thermal shock.
- 2) Vacuum pick-up tool or plastic tweezers are recommended for handling the components. Extra care should be taken not to scratch the filter or metal area.
- 3) Use 2-3 mil thickness stencil plate and screen print the solder. Refer below picture for recommended stencil pattern to get the best solder attachment.

Stencil opening drawing

Solder location after screen print



- 4) Plugged ground vias in the PWB will improve attachment consistency.
- Recommended to have a similar or closer test board material and thickness (refer Mini-Circuits evaluation board for details) to minimize the CTE over the temperature range.

Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits website at www.minicircuits.com/MCLStore/terms.jsp

Typical Performance Data

| FREQ. | Insertion Loss | Input Return Loss | Output Return Loss |
|----------------|------------------|----------------------|-----------------------|
| (MHz) | (dB) | (dB) | (dB) |
| 10 | 114.71 | 0.03 | 0.03 |
| 50 | 114.25 | 0.07 | 0.08 |
| 100 | 111.74 | 0.12 | 0.11 |
| 500 | 120.14 105.71 | 0.19 | 0.20 |
| 1000 2000 | 105.71 | 0.21 0.13 | 0.22 0.20 |
| 3000 | 93.70 | 0.02 | 0.02 |
| 4000 | 81.81 | 0.06 | 0.04 |
| 5000 | 72.46 | 0.05 | 0.06 |
| 6000 | 64.18 | 0.01 | 0.04 |
| 7000 | 58.24 | 0.00 | 0.07 |
| 8000 | 53.65 50.65 | 0.04 | 0.00 |
| 9000 10000 | 47.76 | 0.01 0.06 | 0.00 0.08 |
| 11000 | 46.01 | 0.00 | 0.11 |
| 12000 | 44.52 | 0.12 | 0.10 |
| 13000 | 43.09 | 0.08 | 0.08 |
| 14000 | 40.45 | 0.12 | 0.13 |
| 15000 | 40.16 | 0.16 | 0.15 |
| 18000 | 39.41 | 0.23 | 0.26 |
| 20000 20400 | 44.38 44.98 | 0.23 0.25 | 0.26 0.25 |
| 20800 | 45.88 | 0.23 | 0.25 |
| 21200 | 46.64 | 0.23 | 0.26 |
| 21600 | 46.93 | 0.23 | 0.28 |
| 22000 | 46.73 | 0.24 | 0.28 |
| 22500 | 45.94 | 0.32 | 0.37 |
| 23200 23425 | 31.51 20.88 | 0.82 1.35 | 0.82 1.36 |
| 23625 | 10.05 | 3.07 | 3.15 |
| 23825 | 3.17 | 11.78 | 12.36 |
| 24250 | 1.61 | 36.24 | 29.45 |
| 24800 | 1.46 | 19.04 | 19.13 |
| 25200 | 1.37 | 30.50 | 26.93 |
| 25875 | 1.40 | 23.68 | 22.33 |
| 26000 26400 | 1.39 1.47 | 30.94 23.70 | 25.38 25.20 |
| 27000 | 1.63 | 31.78 | 27.84 |
| 27500 | 2.07 | 25.48 | 30.34 |
| 27900 | 3.01 | 21.48 | 34.66 |
| 28000 | 3.82 | 14.56 | 18.15 |
| 28200 | 10.00 | 4.07 | 4.51 |
| 28400 28625 | 19.95 30.01 | 2.08 1.46 | 2.13 1.38 |
| 29000 | 43.67 | 0.94 | 0.85 |
| 29250 | 50.51 | 0.68 | 0.67 |
| 30200 | 66.85 | 0.22 | 0.29 |
| 30800 | 65.65 | 0.07 | 0.21 |
| 31000 | 65.18 | 0.05 | 0.21 |
| 31600 32000 | 66.03 64.56 | 0.05 0.07 | 0.24 0.28 |
| 32000 32400 | 61.13 | 0.07 | 0.28 |
| 33000 | 58.89 | 0.25 | 0.43 |
| 33400 | 58.41 | 0.36 | 0.46 |
| 35000 | 57.52 | 0.50 | 0.51 |
| 36000 | 57.91 | 0.48 | 0.62 |
| 37000 | 55.68 | 1.08 | 1.62 |
| 38000 39000 | 46.51 40.06 | 2.75 0.92 | 2.32 0.83 |
| 40000 | 38.60 | 0.92 0.74 | 0.83 0.75 |
| 70000 | 50.00 | 0.74 | 0.10 |

| FREQ. | Group Delay |
|----------------------------------|------------------------------|
| (MHz) | (ns) |
| | |
| 26850 26900 26950 | 0.54 0.54 0.55 |
| 27000 27050 27100 27300 | 0.55 0.56 0.57 0.60 |
| 27500 | 0.66 |

27500

0.66

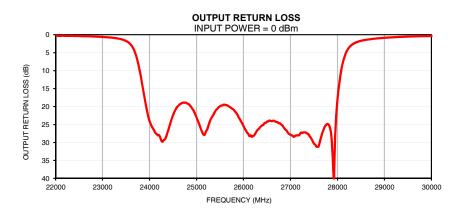
Typical Performance Curves

35

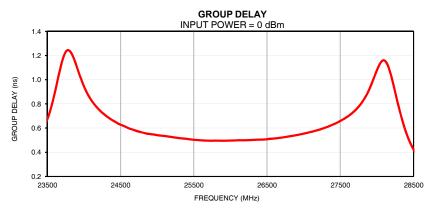
22000

24000



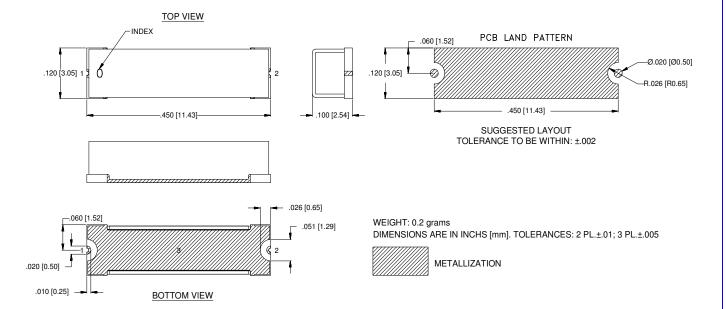


) 26000 FREQUENCY (MHz)



Outline Dimensions

VG3044



Notes:

- 1. Case material: Gold over Nickel over Annealed Stainless Steel.
- 2. Base: Ceramic
- 3. Termination finish: as shown below or indicated on Data Sheet.

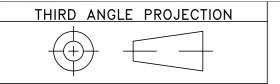
For RoHS Case Styles: Gold over Nickel plate. All models, (+) suffix.





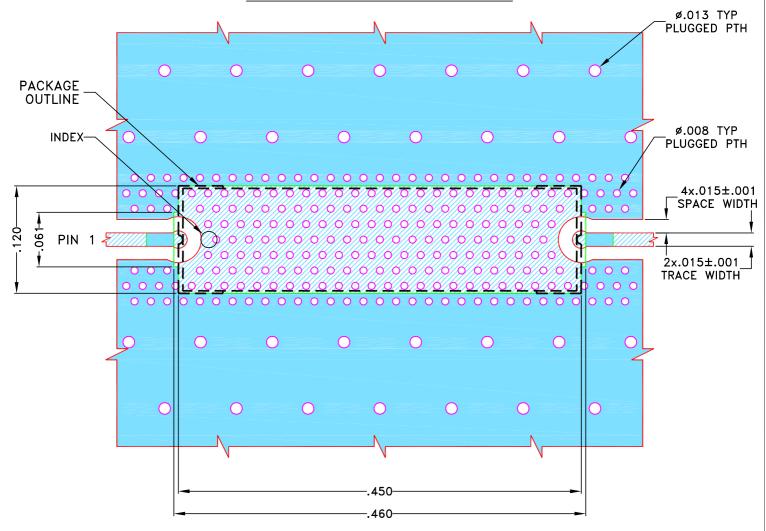
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com



| | | REVISIONS | | | |
|-----|------------|-------------|--------|-----|------|
| REV | ECN No. | DESCRIPTION | DATE | DR | AUTH |
| OR | NPO-001850 | NEW RELEASE | JUL 21 | DDR | VC |
| | | | | | |
| | | | | | |
| | | | | | |

SUGGESTED MOUNTING CONFIGURATION FOR VG3044 CASE STYLE



NOTES:

- 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS (RO4350B) WITH DIELECTRIC THICKNESS .0066±.0007. COPPER: 1/2 Oz. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

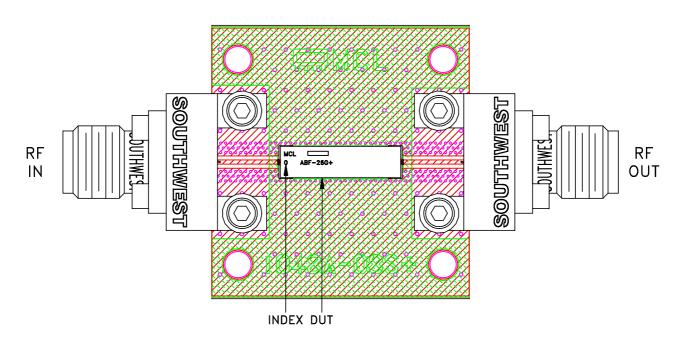
DENOTES PCB COPPER PATTERN WITH SMOBC (SOLDER MASK OVER BARE COPPER)

DENOTES PCB COPPER PATTERN FREE OF SOLDERMASK

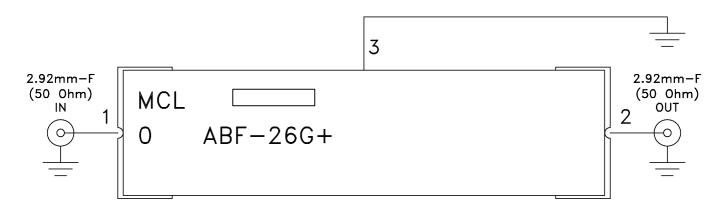
| UNLESS OTHERWISE SPECIFIED | | INITIALS | DATE | | ¬ ¬, , , , . | | | • 4 R | | | |
|---|------------|----------|-------------|---|--------------|---------------|--------|--------|-----------------------|------------------|---------------|
| DIMENSIONS ARE IN INCHES | DRAWN | DDR | 06 JUL 21 |] | 🛮 Mini | l – (C | ırcu | ıts | 13 Neptur Brooklyn | ne Avenu | e |
| TOLERANCES ON: 2 PL DECIMALS ± | CHECKED | RR | 06 JUL 21 | | Γ | | | | вгоокіуп | NI 11236 | , |
| 3 PL DECIMALS ± .005 ANGLES ± | APPROVED | NN | 06 JUL 21 |] | | | | | | | |
| FRACTIONS ± | | | |]PL] | DWG, Vo | G304 | 4 C.S. | . 50 | OHM | \mathbf{I} . A | BF |
| □ Mini−Circuits ® | | |] | - · · · · · · · · · · · · · · · · · · · | | | , | | -, | | |
| THIS DOCUMENT AND ITS CONTENTS A EXCEPT FOR USE EXPRESSLY GRANTED | | | | SIZE | CODE IDENT | DRAWING | NO. | | | REV: | |
| AND THE UNITED STATES GOVERNMENT, MINI-CIRCUITS RESERVES ALL PROPRIETARY DESIGN, USE, MANUFACTURING AND REPRODUCTION RIGHTS THERETO. THESE CONTENTS SHALL NOT BE USED, DUPLICATED OR DISCLOSED TO ANY OUTSIDE | | | A | 15542 | DRAWING | 98-PL | -713 | | OF | 3 | |
| PARTY, IN WHOLE OR IN PART, WITHOU | ASHEETA1.D | | TE:01/12/95 | FILE: 98 | B-PL-713 | SCALE: | 9:1 | SHEET: | 1 | OF 1 | |

Evaluation Board and Circuit

TB-ABF-26G+



Schematic diagram



Notes:

- 1. PCB Material: ROGERS (RO4350B) OR Equivalent, Dielectric Constant= $3.48\pm.05$ Dielectric Thickness: .0066" \pm .0007"
- 2. 50 Ohm 2.92mm Female Connectors.

☐ Mini-Circuits®



ENV120



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification | Test/Inspection Condition | Reference/Spec |
|-----------------------|---------------------------------------|---|
| Operating Temperature | -55° to 125° C Ambient Environment | Individual Model Data Sheet |
| Storage Temperature | -55° to 125° C Ambient Environment | Individual Model Data Sheet |
| Solderability | 10X Magnification | J-STD-002, Para 4.2.5, Test S, 95% Coverage |
| Thermal Shock | -55° to 125°C, 100 cycles | MIL-STD-202, Method 107, Condition A-3, Except +125°C |

ENV120 Rev: OR

04/30/21

DCO-0453 File: ENV120.pdf